

Docket No. \_\_\_\_\_

**COMBINED DECLARATION/POWER OF ATTORNEY**  
**FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME**

, the specification of which

(check one)  is attached hereto.

— was filed on \_\_\_\_\_ as  
 Application Serial No. \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)	Priority Claimed
2003-082422 (Number)	JAPAN (Country) 25/03/2003 (Day/Month/Year Filed) <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
_____ (Number)	_____ (Country) _____ (Day/Month/Year Filed) <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
_____ (Number)	_____ (Country) _____ (Day/Month/Year Filed) <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)

I hereby appoint as my attorneys, with full power of substitution and revocation, to prosecute the patent application identified above and to transact all business in the U.S. Patent and Trademark Office connected therewith: Raphael V. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. (Reg. No. 28,149); Kenneth L. Cage (Reg. No. 26,151); Stanislaus Aksman (Reg. No. 28,562); Paul Devinsky (Reg. No. 28,553); Edward E. Kubasiewicz (Reg. No. 30,020), Michael E. Fogarty (Reg. No. 36,139); Brian E. Ferguson (Reg. No. 36,801); Robert W. Zelnick (Reg. No. 36,976); and Wilhlem F. Gadiano (Reg. No. 37,136).

Please address all correspondence and telephone calls to:

Jack Q. Lever, Jr.  
 McDERMOTT, WILL & EMERY  
 600 Thirteenth Street, N.W.  
 Washington, D.C. 20005-3096  
 (202) 756-8000

The undersigned hereby authorizes the U.S. attorneys named herein to accept and follow instructions from Maeda Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by the undersigned.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Hisashi NAKAYAMA

Inventor's signature Hisashi Nakayama Date March 22, 2004  
 Residence\* Kyoto, Japan Citizenship Japan  
 Post Office Address 1-9-3, Tenjin, Nagaokakyo-shi, Kyoto 617-0824, Japan

Full name of second inventor Tetsuzo UEDA

Inventor's signature Tetsuzo Ueda Date March 22, 2004  
Residence\* Osaka, Japan Citizenship Japan  
Post Office Address 4-16-3-301, Kitasakurazuka, Toyonaka-shi, Osaka 560-0022, Japan

Full name of third inventor Masaaki YURI

Inventor's signature Masaaki YURI Date March 22, 2004  
Residence\* Osaka, Japan Citizenship Japan  
Post Office Address 6-26-1201, Funaki-cho, Ibaraki-shi, Osaka 567-0828, Japan

\* City and State, or City and Country for foreign inventors

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of : Customer Number: 20277  
 Hisashi NAKAYAMA, et al. : Confirmation Number:  
 Serial No.: : Group Art Unit:  
 Filed: March 25, 2004 : Examiner: Unknown  
 For: **SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME**

**ASSOCIATE POWER OF ATTORNEY**

Mail Stop  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Sir:

The undersigned Principal Attorney of record hereby appoints the following Attorneys as his Associates with regard to the above-identified application: Stephen A. Becker, Reg. No. 26,527; John G. Bisbikis, Reg. No. 37,095; Richard E. Brown, Reg. No. 47,453; Daniel Bucca, Reg. No. 42,368; Kenneth L. Cage, Reg. No. 26,151; Bernard P. Codd, Reg. No. 46,429; Lawrence T. Cullen, Reg. No. 44,489; Paul Devinsky, Reg. No. 28,553; Margaret M. Duncan, Reg. No. 30,879; Ramyar M. Farid, Reg. No. 46,692; Michael E. Fogarty, Reg. No. 36,139; John R. Fuisz, Reg. No. 37,327; Keith E. George, Reg. No. 34,111; Thomas A. Haag, Reg. No. 47,621; John A. Hankins, Reg. No. 32,029; Catherine Krupka, Reg. No. 46,227; Jack Q. Lever, Reg. No. 28,149; Michael A. Messina, Reg. No. 33,424; Dawn L. Palmer, Reg. No. 41,238; Joseph H. Paquin, Jr., Reg. No. 31,647; Scott D. Paul, Reg. No. 42,984; William D. Pegg, Reg. No. 42,988; Gene Z. Rubinson, Reg. No. 33,351; Brian K. Seidleck, Reg. No. 51,321; Joy Ann G. Serauskas, Reg. No. 27,952; David A. Spenard, Reg. No. 37,449; Arthur J. Steiner, Reg. No. 26,106; David M. Tennant, Reg. No. 48,362; Judith L. Toffenetti, Reg. No. 39,048; Kelli N. Watson, Reg. No. 47,170; Cameron K. Weiffenbach, Reg. No. 44,488; Aaron Weisstuch, Reg. No. 41,557; Edward J. Wise, Reg. No. 34,523; Jeffrey A. Woller, Reg. No. 48,041; Alexander V. Yampolsky, Reg. No. 36,324; William Young, Reg. No. 54,718; and Wei-Chen Chen and Tomoki Tanida, admitted under 37 CFR 10.9(b) all of

McDERMOTT, WILL & EMERY  
 600 13th Street, N.W.  
 Washington, DC 20005-3096

Please continue to address all communications to the undersigned.

March 25, 2004

By   
 Ramyar M. Farid  
 Registration No. 46,692  
 Attorney for Applicant